TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74AC08P, TC74AC08F, TC74AC08FT

### Quad 2-Input AND Gate

The TC74AC08 is an advanced high speed CMOS 2-INPUT AND GATE fabricated with silicon gate and double-layer metal wiring  $C^2$ MOS technology.

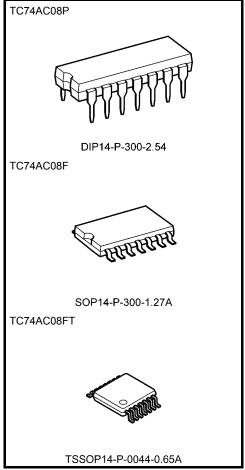
It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The internal circuit is composed of 2 stages including buffer output, which provide high noise immunity and stable output.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### **Features**

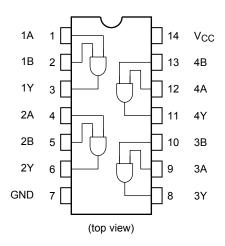
- High speed:  $t_{pd} = 3.4 \text{ ns (typ.)}$  at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 4 \mu A \text{ (max)}$  at  $T_a = 25 \text{°C}$
- High noise immunity: V<sub>NIH</sub> = V<sub>NIL</sub> = 28% V<sub>CC</sub> (min)
- Symmetrical output impedance:  $|I_{OH}| = I_{OL} = 24 \text{ mA (min)}$  Capability of driving 50  $\Omega$  transmission lines.
- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: VCC (opr) = 2 V to 5.5 V
- Pin and function compatible with 74F08



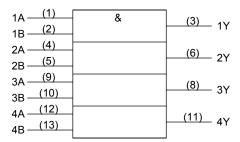
Weight

DIP14-P-300-2.54 : 0.96 g (typ.) SOP14-P-300-1.27A : 0.18 g (typ.) TSSOP14-P-0044-0.65A : 0.06 g (typ.)

#### **Pin Assignment**



#### **IEC Logic Symbol**



#### **Truth Table**

Α	В	Υ			
L	L	L			
L	Н	L			
Н	L	L			
Н	Н	Н			

## **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	−0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
DC output voltage	V <sub>OUT</sub>	−0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>	±20	mA
Output diode current	lok	±50	mA
DC output current	lout	±50	mA
DC V <sub>CC</sub> /ground current	Icc	±100	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP/TSSOP)	mW
Storage temperature	T <sub>stg</sub>	−65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40°C to 65°C. From Ta = 65°C to 85°C a derating factor of -10 mW/°C should be applied up to 300 mW.



## **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit	
Supply voltage	V <sub>CC</sub>	2.0 to 5.5	V	
Input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	V	
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	V	
Operating temperature	T <sub>opr</sub>	−40 to 85	°C	
Input rise and fall time	dt/dV	0 to 100 (V <sub>CC</sub> = 3.3 ± 0.3 V)	ns/V	
input rise and rail unie	αναν	0 to 20 (V <sub>CC</sub> = 5 ± 0.5 V)	113/ V	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

### **Electrical Characteristics**

### **DC Characteristics**

Characteristics Symbol	Symbol		Test Condition			Ta = 25°C			Ta = −40 to 85°C		Unit
				V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	Offic	
					2.0	1.50	_	_	1.50	_	
High-level input voltage	V <sub>IH</sub>	_		3.0	2.10	_	_	2.10	_	V	
					5.5	3.85	_	_	3.85	_	
					2.0	_	_	0.50	_	0.50	
Low-level input voltage	$V_{IL}$		_		3.0	_	_	0.90	_	0.90	V
					5.5	_	_	1.65	_	1.65	
		V <sub>IN</sub> = V <sub>IH</sub>	I <sub>OH</sub> = -50 μA		2.0	1.9	2.0	_	1.9	_	
					3.0	2.9	3.0	_	2.9	_	
High-level output	VoH			4.5	4.4	4.5	_	4.4	_	V	
voltage	▼On		$I_{OH} = -4 \text{ mA}$		3.0	2.58	_	_	2.48	_	V
			I <sub>OH</sub> = -24 mA		4.5	3.94	_	_	3.80	_	
			I <sub>OH</sub> = -75 mA	(Note)	5.5	_	_	_	3.85	_	
		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>			2.0	_	0.0	0.1	_	0.1	
			I <sub>OL</sub> = 50 μA		3.0	_	0.0	0.1	_	0.1	
Low-level output voltage V	V <sub>OL</sub>				4.5	_	0.0	0.1	_	0.1	V
	*OL		I <sub>OL</sub> = 12 mA		3.0	_	_	0.36	_	0.44	·
			I <sub>OL</sub> = 24 mA		4.5	_	_	0.36	_	0.44	
			I <sub>OL</sub> = 75 mA	(Note)	5.5	_	_	_	_	1.65	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	ı	ı	±0.1	ı	±1.0	μΑ	
Quiescent supply current	Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND			5.5	_	_	4.0	ı	40.0	μΑ

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Note: This spec indicates the capability of driving 50  $\Omega$  transmission lines.

One output should be tested at a time for a 10 ms maximum duration.



# AC Characteristics (C<sub>L</sub> = 50 pF, R<sub>L</sub> = 500 $\Omega$ , input: $t_r$ = $t_f$ = 3 ns)

Characteristics Symbol	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit
	,		V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
Propagation delay time tphh	t <sub>pLH</sub>		$3.3 \pm 0.3$	_	5.8	9.8	1.0	11.3	20
	t <sub>pHL</sub>	1	5.0 ± 0.5	_	4.5	7.0	1.0	8.0	ns
Input capacitance	C <sub>IN</sub>	_		_	5	10	_	10	pF
Power dissipation capacitance	C <sub>PD</sub>		(Note)	_	71			_	pF

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

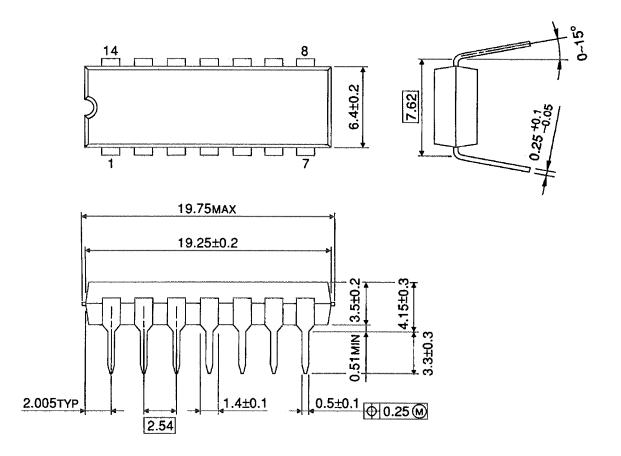
Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/4 (per gate)$ 



# **Package Dimensions**

DIP14-P-300-2.54 Unit: mm

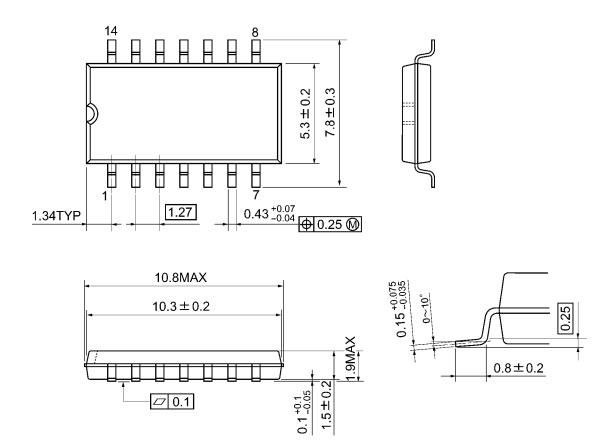


Weight: 0.96 g (typ.)



## **Package Dimensions**

SOP14-P-300-1.27A Unit: mm



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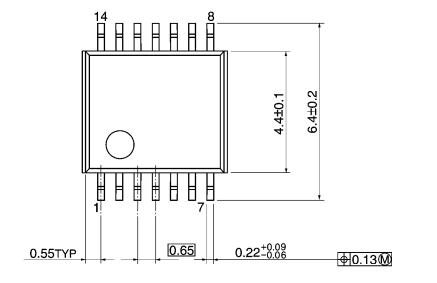
Weight: 0.18 g (typ.)

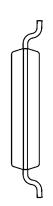


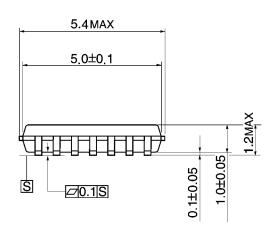
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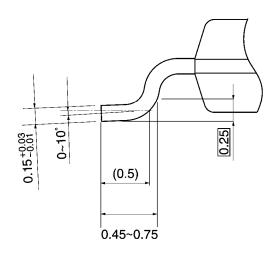
TSSOP14-P-0044-0.65A

Unit: mm









Weight: 0.06 g (typ.)

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